



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:  Madhav Datta et al.  Application No.: 10/776,076  Filed: February 10, 2004  For: COPPER-CONTAINING C4 BALL-LIMITTING METALLURGY STACK FOR ENHANCED RELIABILITY OF PACKAGED STRUCTURES AND METHOD OF MAKING SAME	Examiner: Thanhha S. Pham  Art Unit: 2813  Confirmation No.: 2094
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MAIL STOP AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

**AMENDMENT AND RESPONSE TO OFFICE ACTION**

Sir:

In response to the Office Action mailed February 23, 2005, applicants respectfully request that the above-identified application be amended as follows.

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450 on May 16, 2005.

Renee Coulman

(Typed or printed name of person mailing correspondence)

(Signature of person mailing correspondence)